## **CLAIMS**

What is claimed is:

1. A transceiver module for use in a fiber-optic network system comprising:

a transceiver module casing;

a transmitter optical subassembly disposed in the transceiver module casing,

wherein the transmitter optical subassembly includes a header assembly having

enclosed therein:

a thermoelectric cooler (TEC); and

an externally modulated laser (EML) for transmission of optical data;

and

a receiver subassembly disposed in the transceiver module casing.

2. A transceiver module as set forth in claim 1 wherein the transmitter optical

subassembly comprises a platform wherein a portion of the platform is exposed external to the

transmitter optical subassembly, and wherein the platform comprises a conductive pathway

extending through the platform.

3. A transceiver module as set forth in claim 2 wherein the conductive pathway

comprises a plurality of isolated traces, wherein the plurality of isolated traces is of a sufficient

number to at least provide control signals to an integrated circuit laser driver.

4. A transceiver module as set forth in claim 2, wherein the conductive pathway

forms a transmission line, wherein the transmission line is adapted to match the impedance of a

component connected to a first end of the conductive pathway with a source intended to drive

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the component wherein the source is indented to be connected to a second end of the conducive pathway.

5. The transceiver module as set forth in claim 4, wherein the transmission line is a

25 ohm transmission line.

6. The transceiver module as set forth in claim 4, wherein the transmission line is a

50 ohm transmission line.

7. A transceiver module as set forth in claim 1 further comprising a module circuit

board disposed in the transceiver module casing.

8. A transceiver module as set forth in claim 7, wherein the transmitter optical

subassembly and the receiver optical subassembly are electrically coupled to the module circuit

board.

9. A transceiver module as set forth in claim 8, wherein the transmitter optical

subassembly and the receiver optical subassembly are electrically coupled to the module circuit

board through a flexible circuit board.

10. A transceiver module as set forth in claim 1 wherein the EML is optimized to

operate at an elevated temperature above an ambient temperature in which the transceiver

module is intended to operate.

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- 11. A transceiver module as set forth in claim 1 further comprising a bail release coupled to an anterior end of the transceiver module casing.
- 12. A transceiver module as set forth in claim 1, wherein the transceiver module is constructed so as to comply with the XFP Multi Source Agreement.

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13. A method of making a transceiver module comprising;

providing a transceiver module casing;

disposing a transmitter optical subassembly in the transceiver module casing, wherein the transmitter optical subassembly includes a header assembly having enclosed therein:

a thermoelectric cooler (TEC); and

an externally modulated laser (EML) for transmission of optical data;

and

placing a receiver subassembly in the transceiver module casing.

14. A method as set forth in claim 13 further comprising installing a module circuit board in the transceiver module casing.

15. A method as set forth in claim 14 further comprising electrically connecting the transmitter optical subassembly and the receiver subassembly to the module circuit board.

16. A method as set forth in claim 15 wherein electrically connecting is accomplished by using at least a flexible printed circuit board.

17. A method as set forth in claim 13 further comprising optimizing the EML for use in applications where the EML is intended to be operated at an elevated temperature above some ambient temperature in which the transceiver is intended to be operated.

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- 18. A method as set forth in claim 13 further comprising attaching a bail release to an anterior end of the transceiver module.
- 19. A method as set forth in claim 14 further comprising forming a pluggable edge connector on a posterior end of the module circuit board.
- 20. A method as set forth in claim 13, wherein the transmitter optical subassembly comprises a platform that extends external to the transmitter optical subassembly, further comprising forming an impedance matching transmission line on the platform.

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21. A transceiver module for use in a fiber-optic network system comprising:

a modular transceiver module casing;

a transmitter optical subassembly disposed in the transceiver module casing,

wherein the transmitter optical subassembly includes a header assembly having

enclosed therein an externally modulated laser (EML) for transmission of optical data,

the EML being adapted for operation at a temperature elevated with respect to an

ambient temperature in which the transceiver module operates; and

a receiver subassembly disposed in the transceiver module casing.

22. A transceiver module as set forth in claim 21, wherein the transceiver module is

capable of use in a dense wavelength division multiplexing application.

23. A transceiver module as set forth in claim 21, wherein the header assembly

further has a thermoelectric cooler (TEC) that is used to stabilize the wavelength of light

generated by the EML.

24. A transceiver module as set forth in claim 21, wherein the EML is cooled only

passively.

25. A transceiver module as set forth in claim 21, wherein the transceiver module is

constructed so as to comply with the XFP Multi Source Agreement.

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VORKMAN NYDEGGE a professional corporation attorneys at law 26. An optical transceiver, comprising:

a pluggable transceiver module casing that complies with the XFP Multi Source

Agreement;

a transmitter optical subassembly disposed in the transceiver module casing,

wherein the transmitter optical subassembly includes a header assembly having

enclosed therein an externally modulated laser (EML) for transmission of optical data;

and

a receiver subassembly disposed in the transceiver module casing.

27. An optical transceiver as set forth in claim 26, wherein the header assembly

further has enclosed therein a thermoelectric cooler for dissipating heat generated by the EML.

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